

TRADEMARK ASSIGNMENT

Electronic Version v1.1
 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT		
NATURE OF CONVEYANCE:	Supplemental Intellectual Property Security Agreement		
CONVEYING PARTY DATA			
Name	Formerly	Execution Date	Entity Type
International Technidyne Corporation		06/18/2013	CORPORATION: DELAWARE
RECEIVING PARTY DATA			
Name:	Comerica Bank		
Street Address:	75 East Trimble Road, M/C 4770		
City:	San Jose		
State/Country:	CALIFORNIA		
Postal Code:	95131		
Entity Type:	a Texas banking association: TEXAS		
PROPERTY NUMBERS Total: 1			
Property Type	Number	Word Mark	
Serial Number:	85601737	ITC ENSEMBLE	
CORRESPONDENCE DATA			
Fax Number:	6179518736		
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent via US Mail.</i>			
Phone:	617-951-8132		
Email:	linda.salera@bingham.com		
Correspondent Name:	Linda A. Salera		
Address Line 1:	One Federal Street		
Address Line 2:	c/o Bingham McCutchen LLP		
Address Line 4:	Boston, MASSACHUSETTS 02110		
NAME OF SUBMITTER:	Linda Salera		
Signature:	/Linda A. Salera/		
Date:	07/17/2013		

OP \$40.00 85601737

Total Attachments: 8

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SUPPLEMENTAL INTELLECTUAL PROPERTY SECURITY AGREEMENT

THIS SUPPLEMENTAL INTELLECTUAL PROPERTY SECURITY AGREEMENT, dated as of June 18, 2013, is entered into by and between INTERNATIONAL TECHNIDYNE CORPORATION, a Delaware corporation (hereinafter, together with its successors in title and assigns, called the "Grantor"), and COMERICA BANK, a Texas banking association (hereinafter, together with its successors in title and assigns, called the "Lender").

Statement of Facts

A. Pursuant to the Loan and Security Agreement, dated as of March 22, 2011, by and among the Grantor, certain of its affiliates and the Lender (as amended, modified, supplemented or restated and in effect from time to time, the "Loan Agreement"), the Lender has made and has agreed to make loans to the Grantor (collectively, the "Loans").

B. In order to induce the Lender to make additional Loans and other credit extensions to the Grantor upon the terms and subject to the conditions contained in the Loan Agreement, the Grantor has agreed, upon the terms contained in the Loan Agreement, to grant to the Lender continuing security interests in and Liens upon all Intellectual Property Collateral (as hereinafter defined) of the Grantor in order to secure all of the Loan Obligations (as defined below).

C. The Grantor has granted to the Lender continuing security interests in and Liens upon all of the Intellectual Property Collateral of the Grantor pursuant to and upon the terms and conditions contained in the Loan Agreement and in that certain Security Agreement, dated as of March 22, 2011, by and among the Grantor, certain of its affiliates and the Lender (as amended, modified, supplemented or restated and in effect from time to time, the "Security Agreement").

D. Upon the terms contained in the Loan Agreement and the Security Agreement, the Grantor has agreed to execute and deliver to the Lender this Supplemental Intellectual Property Security Agreement, which is supplemental to the Loan Agreement and the Security Agreement.

NOW, THEREFORE, in consideration of the premises and the mutual covenants herein contained and for other good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, the Grantor hereby absolutely, unconditionally and irrevocably agrees with the Lender as follows:

1. **Definitions.** All capitalized terms used but not otherwise defined herein shall have the meanings given to them in or by reference in the Security Agreement, and the following terms shall have (unless otherwise provided elsewhere in this Supplemental Intellectual Property Security Agreement) the following respective meanings (such meanings being equally applicable to both the singular and plural forms of the terms defined):

(a) "Intellectual Property Collateral" shall mean all of the rights, title and interests of the Grantor in, to and under all of the following, whether presently existing or at any time or from time to time hereafter created, arising or acquired:

- (i) the Trademark Application referred to in Schedule I hereto;
- (ii) the Patent Application referred to in Schedule II hereto;
- (iii) all goodwill of the businesses of the Grantor connected with the use of, or otherwise symbolized by, each such Trademark Application and Patent Application; and
- (iv) all income, products and proceeds of each of the foregoing, including, without limitation, all claims by the Grantor against third parties for past, present or future (A) infringement or dilution of any Trademark described in any such Trademark Application or any Patent described in any such Patent Application, and (B) injury to any goodwill associated with any Trademark described in any such Trademark Application or any Patent described in any such Patent Application.

(b) "Loan Agreement" and "Security Agreement" shall have the meanings given to such terms in the Statement of Facts above.

(c) "Loan Obligations" shall mean any and all of the Obligations (as that term is defined in the Loan Agreement).

All other terms contained in this Supplemental Intellectual Property Security Agreement shall, unless the context shall indicate otherwise, have the meanings provided for by the U.C.C. to the extent that such other terms are used or defined therein and are not otherwise defined in or by reference in the Security Agreement. References to the Loan Agreement or the Security Agreement include any amendment, modification, supplement, restatement, replacement or refinancing (in whole or in part) thereof, whether by way of increase or reduction to any of the Commitments or the principal amount of any of the Loans, addition or elimination of any credit facilities thereunder, extension of any term, addition or deletion of any party thereto, or otherwise.

2. Grant of Security Interests. To secure the prompt and complete payment and performance of all and each of the Loan Obligations, as and when the same shall become due and payable, whether at stated maturity, by required prepayment, declaration, acceleration, demand or otherwise (including the payment of amounts that would become due and payable but for the operation of the automatic stay under the Bankruptcy Code), the Grantor hereby grants to the Lender a continuing security interest in and Lien upon all of the rights, title and interests of the Grantor to, in and under the Intellectual Property Collateral.

3. Loan Agreement and Security Agreement. The security interests and Liens granted by the Grantor to the Lender pursuant to this Supplemental Intellectual Property Security Agreement are granted in conjunction with the security interests and Liens granted by the Grantor to the Lender pursuant to the Loan Agreement and the Security Agreement. The Grantor and the Lender expressly agree that each of the security interests and Liens granted under this Supplemental Intellectual Property Security Agreement, the Security Agreement and the Loan Agreement in the Intellectual Property Collateral are intended to be treated as a single security interest for purposes of Article 9 of the U.C.C. and other Applicable Law. The exercise by the Lender of any rights or remedies with respect to any of the Intellectual Property Collateral shall

be deemed to be an exercise of such rights or remedies in connection with both this Supplemental Intellectual Property Security Agreement and also the Loan Agreement and the Security Agreement. In the event of any inconsistency between the terms and conditions of this Supplemental Intellectual Property Security Agreement and the Loan Agreement and the Security Agreement, then the terms and conditions of the Loan Agreement and the Security Agreement shall prevail.

4. **Notices.** Except as otherwise provided herein, whenever it is provided herein that any notice, demand, request, consent, approval, declaration or other communication shall or may be given to or served upon any of the parties hereto by any other party hereto, or whenever any of the parties hereto desires to give and serve upon any other party hereto any communication with respect to this Supplemental Intellectual Property Security Agreement, each such notice, demand, request, consent, approval, declaration or other communication shall be in writing and shall be given in the manner, and deemed received, as provided for in the notice provisions of the Loan Agreement.

5. **Choice Of Law And Venue; Jury Trial Waiver.** THIS SUPPLEMENTAL INTELLECTUAL PROPERTY SECURITY AGREEMENT SHALL BE GOVERNED BY, AND CONSTRUED IN ACCORDANCE WITH, THE LAWS OF THE STATE OF CALIFORNIA. EACH OF THE GRANTOR AND THE LENDER HEREBY SUBMITS TO THE EXCLUSIVE JURISDICTION OF THE STATE AND FEDERAL COURTS LOCATED IN THE STATE OF CALIFORNIA. EACH OF THE LENDER AND THE GRANTOR ACKNOWLEDGES THAT THE RIGHT TO TRIAL BY JURY IS A CONSTITUTIONAL ONE, BUT THAT IT MAY BE WAIVED. EACH OF THEM, AFTER CONSULTING OR HAVING HAD THE OPPORTUNITY TO CONSULT WITH COUNSEL OF THEIR CHOICE, KNOWINGLY, VOLUNTARILY AND INTENTIONALLY WAIVES ANY RIGHT ANY OF THEM MAY HAVE TO A TRIAL BY JURY IN ANY LITIGATION BASED UPON OR ARISING OUT OF THIS SUPPLEMENTAL INTELLECTUAL PROPERTY SECURITY AGREEMENT OR ANY OF THE TRANSACTIONS CONTEMPLATED BY THIS SUPPLEMENTAL INTELLECTUAL PROPERTY SECURITY AGREEMENT OR ANY COURSE OF CONDUCT, DEALING, STATEMENTS (WHETHER ORAL OR WRITTEN), OR ACTION OF ANY OF THEM. THESE PROVISIONS SHALL NOT BE DEEMED TO HAVE BEEN MODIFIED IN ANY RESPECT OR RELINQUISHED BY THE LENDER OR THE GRANTOR, EXCEPT BY A WRITTEN INSTRUMENT EXECUTED BY EACH OF THEM.

6. **Delivery by Facsimile or Electronic Mail.** Delivery of an executed counterpart of this Supplemental Intellectual Property Security Agreement by facsimile transmission or electronic mail in portable document format (.pdf) shall be as effective as delivery of an original manually executed counterpart of this Supplemental Intellectual Property Security Agreement.

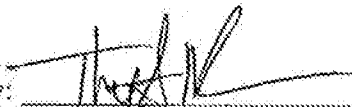
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Signature Page to ITC Supplemental Intellectual Property Security Agreement follows

IN WITNESS WHEREOF, the Grantor has caused this SUPPLEMENTAL INTELLECTUAL PROPERTY SECURITY AGREEMENT to be executed and delivered by its duly authorized officer or other representative as of the date first set forth above.

The Grantor:

INTERNATIONAL TECHNIDYNE CORPORATION

By: 
Name: Tom Bielan
Title: CFO

The Lender:

COMERICA BANK

By: 
Name: Paula J. Howell
Title: Senior Vice President

****Signature Page to ITC Supplemental Intellectual Property Security Agreement****

SCHEDULE I

To

INTERNATIONAL TECHNIDYNE CORPORATION

INTELLECTUAL PROPERTY SECURITY AGREEMENT

A. U.S. TRADEMARK REGISTRATIONS.

<u>Mark</u>	<u>Registration Number</u>	<u>Registration Date</u>
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None.

B. U.S. TRADEMARK APPLICATIONS.

<u>Mark</u>	<u>Application Number</u>	<u>Date</u>
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See attached Annex A.

C. U.S. TRADEMARK LICENSES.

<u>Name of Agreement</u>	<u>Date of Agreement</u>	<u>Parties</u>
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None.

ANNEX A

to

SCHEDULE I

to

INTERNATIONAL TECHNIDYNE CORPORATION
INTELLECTUAL PROPERTY SECURITY AGREEMENT

U.S. TRADEMARK APPLICATIONS

<u>Mark</u>	<u>Application Number</u>	<u>Date</u>
I TC ENSEMBLE	85601737 APP. NO.	18-APR-2012 APP. FILED PUBLISHED (PENDING)

SCHEDULE II

To

INTERNATIONAL TECHNIDYNE CORPORATION

INTELLECTUAL PROPERTY SECURITY AGREEMENT

A. U.S. PATENT REGISTRATIONS.

<u>Patent</u>	<u>Registration Number</u>	<u>Registration Date</u>	<u>Status/Comments</u>
<u>None.</u>			

B. U.S. PATENT APPLICATIONS.

<u>Patent</u>	<u>Application Number</u>	<u>Date</u>	<u>Status/Comments</u>
See attached <u>Annex A.</u>			

C. U.S. PATENT LICENSES.

<u>Name of Agreement</u>	<u>Date of Agreement</u>	<u>Parties</u>
<u>None.</u>		

ANNEX A

to

SCHEDULE II

to

INTERNATIONAL TECHNIDYNE CORPORATION

INTELLECTUAL PROPERTY SECURITY AGREEMENT

U.S. PATENT APPLICATIONS

<u>Patent</u>	<u>Application Number</u>	<u>Date</u>	<u>Status/ Comments</u>
CUVETTE-BASED APPARATUS FOR BLOOD COAGULATION MEASUREMENT AND TESTING	13/474243	05/17/2012	PENDING 2013/0017126